

2SP0115T2B0-FF150R12ME3G and 2SP0115T2B0C-FF150R12ME3G Data Sheet

Compact, high-performance, plug-and-play dual-channel IGBT driver based on SCALE[™]-2 technology for individual and parallel-connected modules

Abstract

The SCALETM-2 plug-and-play driver 2SP0115T2B0-FF150R12ME3G / 2SP0115T2B0C-FF150R12ME3G (Coated version using ELPEGUARD SL 1307 FLZ/2 from Lackwerke Peters with a typical thickness of 50µm) is a compact dual-channel intelligent gate driver designed for Infineon's EconoDUALTM IGBTs FF150R12ME3G. The driver features an electrical interface with a built-in DC/DC power supply.

For drivers adapted to other types of high-power and high-voltage IGBT modules, refer to

www.power.com/gate-driver/go/plug-and-play

Features	Applications
 Plug-and-play solution Allows parallel connection of IGBT modules Shortens application development time Extremely reliable; long service life Built-in DC/DC power supply 20-pin flat cable interface Duty cycle 0 100% Active clamping of V_{ce} at turn-off IGBT short-circuit protection Monitoring of supply voltage Safe isolation to EN 50178 UL compliant Suitable for FF150R12ME3G 	 Wind-power converters Industrial drives UPS Power-factor correctors Traction Railroad power supplies Welding SMPS Radiology and laser technology Research and many others

EconoDUAL is a trademark of Infineon Technologies AG, Munich



Safety Notice!

The data contained in this data sheet is intended exclusively for technically trained staff. Handling all high-voltage equipment involves risk to life. Strict compliance with the respective safety regulations is mandatory!

Any handling of electronic devices is subject to the general specifications for protecting electrostatic-sensitive devices according to international standard IEC 60747-1, Chapter IX or European standard EN 100015 (i.e. the workplace, tools, etc. must comply with these standards). Otherwise, this product may be damaged.

Important Product Documentation

This data sheet contains only product-specific data. For a detailed description, must-read application notes and common data that apply to the whole series, please refer to "Description & Application Manual for 2SP0115T SCALE-2 IGBT Drivers" on www.power.com/gate-driver/go/2SP0115T.

When applying SCALE-2 plug-and-play drivers, please note that these drivers are specifically adapted to a particular type of IGBT module. Therefore, the type designation of SCALE-2 plug-and-play drivers also includes the type designation of the corresponding IGBT module. These drivers are not valid for IGBT modules other than those specified. Incorrect use may result in failure.

Mechanical Dimensions

Dimensions: Refer to "Description & Application Manual for 2SP0115T SCALE-2 IGBT Drivers" Mounting principle: Soldered onto EconoDUAL[™] module FF150R12ME3G

Absolute Maximum Ratings

Parameter	Remarks	Min	Мах	Unit
Supply voltage V _{CC}	VCC to GND	0	16	V
Logic input and output voltages	To GND	-0.5	VCC+0.	5 V
SO _x current	Fault condition, total current		20	mA
Gate peak current Iout	Note 1	-8	+15	Α
Average supply current I _{CC}	Note 2		290	mA
Output power per gate	Ambient temperature \leq 70°C (Note 3)		1.2	W
	Ambient temperature \leq 85°C (Note 3)		1	W
Switching frequency f			40	kHz
Test voltage (50Hz/1min.)	Primary to secondary (Note 16)		3800	V _{AC(eff)}
	Secondary to secondary (Note 16)		3800	VAC(eff)
DC-link voltage	Note 4		800	V
dV/dt	Rate of change of input to output voltage		50	kV/µs
Operating voltage	Primary/secondary, secondary/secondary		1200	Vpeak



Parameter	Remarks	Min	Max	Unit
Operating temperature		-40	85	°C
Storage temperature	Note 20	-40	50	°C
Surface temperature	Only 2SP0115T2B0C-FF150R12ME3G (Note 21)		125	°C

Recommended Operating Conditions

Parameter	Remarks	Min	Тур	Max	Unit
Supply voltage V _{CC}	To GND	14.5	15	15.5	V
Resistance from TB to GND	Blocking time \neq 0, ext. value	128		∞	kΩ
SO _x current	Fault condition, 3.3V logic			4	mA

Electrical Characteristics

Power Supply	Remarks	Min	Тур	Max	Unit
Supply current Icc	Without load		33		mA
Efficiency η	Internal DC/DC converter		85		%
Coupling capacitance Cio	Primary side to secondary side, total, per	channel	23		pF
Power Supply Monitoring	Remarks	Min	Тур	Max	Unit
Supply threshold Vcc	Primary side, clear fault	11.9	12.6	13.3	V
	Primary side, set fault (Note 5)	11.3	12.0	12.7	V
Monitoring hysteresis	Primary side, set/clear fault	0.35			V
Supply threshold Visox-Veex	Secondary side, clear fault	12.1	12.6	13.1	V
	Secondary side, set fault (Note 6)	11.5	12.0	12.5	V
Monitoring hysteresis	Secondary side, set/clear fault	0.35			V
Supply threshold Veex-VCOMx	Secondary side, clear fault	5	5.15	5.3	V
	Secondary side, set fault (Note 6)	4.7	4.85	5	V
Monitoring hysteresis	Secondary side, set/clear fault	0.15			V
Logic Inputs and Outputs	Remarks	Min	Тур	Max	Unit
Input impedance	V(INx) > 3V (Note 7)	3.5	4.1	4.6	kΩ
Turn-on threshold	V(INx) (Note 8)		2.6		V
Turn-off threshold	V(INx) (Note 8)		1.3		V
SOx output voltage	Fault condition, I(SOx) < 8mA			0.7	V



Vce-monitoring threshold Response time DC-link voltage > 550V (Note 9)10.2VResponse time Delay to IGBT turn-off Blocking timeAfter the response time (Note 10)1.4 μ sBlocking timeAfter fault (Note 11)90msTiming CharacteristicsRemarksMinTypMaxUnitTurn-on delay ta(m) Ditter of turn-off delay ta(m) Note 12Note 1275nsTurn-off delay ta(m) Dutput rise time tr(wt) Ga to Ex (Note 13)5ns10.2ysOutput fail time t(wt) Dead time between outputs Half-bridge mode Half-bridge mode (Note 19)3 μ s μ sDutputsRemarksMinTypMaxUnitTurn-off gate resistor Rg(m) Ga to Ex (Note 13)0nsnsOutputsRemarksMinTypMaxUnitTurn-off gate resistor Rg(m) P=1.2WNote 158.2 Ω Turn-off gate resistor Rg(m) P=0W P=1.2WNote 158.2 Ω Cate resistance to COMxRemarksMinTypMaxElectrical IsolationRemarksMinTypMaxTest voltage (50Hz/1s) Primary to secondary side (Note 16) Secondary to secondary side (Note 17)300038503900VerrPartial discharge extinction voit.Primary to secondary side (Note 17)1220V peskVpeskCreepage distancePrimary to secondary side (Note 17)1200V peskVpeskCreepage distancePrimary to secondary side6.6 </th <th>Short-circuit Protection</th> <th>Remarks</th> <th>Min</th> <th>Тур</th> <th>Max</th> <th>Unit</th>	Short-circuit Protection	Remarks	Min	Тур	Max	Unit
Delay to IGBT turn-off Blocking timeAfter the response time (Note 10)1.4μsBlocking timeAfter fault (Note 11)90msTiming CharacteristicsRemarksMinTypMaxUnitTurn-off delay ta(on) Turn-off delay ta(on)Note 1275nsTurn-off delay ta(on) Utput rise time tr(out)Note 18±2nsJitter of turn-ond delay Utput rise time tr(out)Gx to Ex (Note 13)5nsOutput file time tr(out) Gx to Ex (Note 13)10nspsDead time between outputs Transmission delay of fault stateHalf-bridge mode (Note 19)3μsJitter of dead time Turn-off gate resistor Rg(on) Gate voltage at turn-on Gate voltage at turn-on Gate voltage at turn-on P=0W8.2ΩGate resistance to COMxP=0W-9.2VVFest voltage (50Hz/1s)Primary to secondary side (Note 16) Secondary to secondary side (Note 17)380038503900VerfPartial discharge extinction volt.Primary to secondary side (Note 17)1200V/veekV/veekCreepage distancePrimary to secondary side (Note 17)1200V/veekV/veekClearance distancePrimary to secondary side6.6mmmmPrimary to secondary side6.6mmMinmmMinClearance distancePrimary to secondary side6.6mmPrimary to secondary side6.6mmMinMinPrimary to secondary side6.6mm	Vce-monitoring threshold	Between auxiliary terminals		10.2		V
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Secondary to secondary side6.6mmPrimary to NTC6.5mmClearance distancePrimary to secondary side12.3mmSecondary to secondary side6.6mm	Creepage distance					
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Clearance distancePrimary to secondary side12.3mmSecondary to secondary side6.6mm						
Secondary to secondary side 6.6 mm	Clearance distance	-				
, $,$ $,$						
		Primary to NTC	6.5			mm

All data refer to $+25^{\circ}$ C and V_{CC} = 15V unless otherwise specified



Footnotes to the Key Data

- 1) The gate current is limited by the gate resistors located on the driver.
- 2) If the specified value is exceeded, this indicates a driver overload. It should be noted that the driver is not protected against overload.
- 3) If the specified value is exceeded, this indicates a driver overload. It should be noted that the driver is not protected against overload. From 70°C to 85°C, the maximum permissible output power can be linearly interpolated from the given data.
- 4) This limit is due to active clamping. Refer to the "Description & Application Manual for 2SP0115T SCALE-2 IGBT Drivers".
- 5) Undervoltage monitoring of the primary-side supply voltage (VCC to GND). If the voltage drops below this limit, a fault is transmitted to the corresponding outputs and the IGBTs are switched off.
- 6) Undervoltage monitoring of the secondary-side supply voltage (Visox to Veex and Veex to COMx which correspond with the approximate turn-on and turn-off gate-emitter voltages). If the corresponding voltage drops below this limit, the IGBT is switched off and a fault is transmitted to the corresponding output.
- 7) The input impedance can be modified to values $<18 \text{ k}\Omega$ (customer-specific solution).
- 8) Turn-on and turn-off threshold values can be increased (customer-specific solution).
- 9) The resulting pulse width of the direct output of the gate drive unit for short-circuit type I (excluding the delay of the gate resistors) is the sum of response time plus delay to IGBT turn-off.
- 10) The turn-off event of the IGBT is delayed by the specified time after the response time.
- 11) Factory set value. The blocking time can be reduced with an external resistor. Refer to the "Description & Application Manual for 2SP0115T SCALE-2 IGBT Drivers".
- 12) Measured from the transition of the turn-on or turn-off command at the driver input to direct output of the gate drive unit (excluding the delay of the gate resistors).
- 13) Output rise and fall times are measured between 10% and 90% of the nominal output swing with an output load of 10Ω and 40nF. The values are given for the driver side of the gate resistors. The time constant of the output load in conjunction with the present gate resistors leads to an additional delay at the load side of the gate resistors.
- 14) Transmission delay of the fault state from the secondary side to the primary status outputs.
- 15) The gate resistors can be leaded or surface mounted. Power Integrations reserves the right to determine which type will be used. Typically, higher quantities will be produced with SMD resistors and small quantities with leaded resistors.
- 16) HiPot testing (= dielectric testing) must generally be restricted to suitable components. This gate driver is suited for HiPot testing. Nevertheless, it is strongly recommended to limit the testing time to 1s slots as stipulated by EN 50178. Excessive HiPot testing at voltages much higher than $850V_{AC(eff)}$ may lead to insulation degradation. No degradation has been observed over 1min. testing at $3800V_{AC(eff)}$. The transformer of every production sample shipped to customers has undergone 100% testing at the given value or higher (< $5100V_{AC(eff)}$) for 1s.
- 17) Partial discharge measurement is performed in accordance with IEC 60270 and isolation coordination specified in EN 50178. The partial discharge extinction voltage between primary and either secondary side is coordinated for safe isolation to EN 50178.
- 18) Jitter measurements are performed with input signals INx switching between 0V and 15V referred to GND, with a corresponding rise time and fall time of 8ns.
- 19) Note that the dead time may vary from sample to sample. A tolerance of approximately ±20% may be expected. If higher timing precisions are required, Power Integrations recommends using direct mode and generating the dead time externally.
- 20) The storage temperature inside the original package (1) or in case the coating material of coated products may touch external parts (2) must be limited to the given value. Otherwise, it is limited to 90°C.
- 21) The component surface temperature, which may strongly vary depending on the operating condition, must be limited to the given value for coated driver versions to ensure long-term reliability of the coating material.



Legal Disclaimer

The statements, technical information and recommendations contained herein are believed to be accurate as of the date hereof. All parameters, numbers, values and other technical data included in the technical information were calculated and determined to our best knowledge in accordance with the relevant technical norms (if any). They may base on assumptions or operational conditions that do not necessarily apply in general. We exclude any representation or warranty, express or implied, in relation to the accuracy or completeness of the statements, technical information and recommendations contained herein. No responsibility is accepted for the accuracy or sufficiency of any of the statements, technical information, recommendations or opinions communicated and any liability for any direct, indirect or consequential loss or damage suffered by any person arising therefrom is expressly disclaimed.



Ordering Information

Our international terms and conditions of sale apply.

Power Integrations Driver Type #	Related IGBT
2SP0115T2B0-FF150R12ME3G (Temperature range –40°C85°C) 2SP0115T2B0C-FF150R12ME3G (Temperature range –40°C85°C, conformal coating)	FF150R12ME3G FF150R12ME3G
Product home page: <u>www.power.com/gate-driver/go/2SP0115T</u>	

Refer to www.power.com/gate-driver/go/nomenclature for information on driver nomenclature

Information about Other Products

For other drivers, evaluation systems product documentation and application support

Please click: www.power.com



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